

Application No.: 10/091,942

Docket No.: JCLA8556

**In The Claims:**

Claim 1 (original) A variable capacitor structure, comprising:

a substrate;

a first type ion-doped well within the substrate, wherein the first type ion-doped well has a cavity;

a first-type ion-doped buried layer in the substrate underneath the first type ion-doped well, wherein the first type ion-doped buried layer and the first type ion-doped well are connected;

a second type ion-doped region at the bottom of the cavity of the first type ion-doped well;

and

a conductive layer over the first type ion-doped buried layer, wherein the conductive layer and the first type ion-doped buried layer are connected.

Claim 2 (original) The variable capacitor of claim 1, wherein the structure further includes a first metal silicide layer over the second type ion-doped region.

Claim 3 (original) The variable capacitor of claim 1, wherein the conductive layer further includes a second type ion-doped deep collector region.

Claim 4 (original) The variable capacitor of claim 3, wherein the structure further includes a second metal silicide layer over the second type ion-doped deep collector region.

Claim 5 (original) The variable capacitor of claim 1, wherein the conductive layer includes a contact.

Claim 6 (original) The variable capacitor of claim 5, wherein the second type ion-doped region and the conductive layer are located within the same active device region of the substrate, and the conductive layer is isolated from the second type ion-doped region through an insulation layer.

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Claim 7 (original) The variable capacitor of claim 1, wherein the structure further includes a second metal silicide layer between the first type ion-doped buried layer and the conductive layer.

Claim 8 (original) The variable capacitor of claim 1, wherein the structure further includes an isolation structure within the first type ion-doped well between the second type ion-doped region and the conductive layer.

Claim 9 (original) The variable capacitor of claim 1, wherein the first type ion-doped buried layer is an N-type buried layer and the second type ion-doped region is a P-doped region.

Claim 10 (original) A variable capacitor structure, comprising:  
a substrate;  
a first type ion-doped well within the substrate, wherein the first type ion-doped region has a shallow trench isolation structure;  
a first type ion-doped buried layer in the substrate underneath the first type ion-doped well, wherein the first type ion-doped buried layer and the first type ion-doped well are connected;  
at least one second type ion-doped region in the first type ion-doped well at the bottom of the shallow trench isolation structure; and  
at least one first conductive layer connected to the first type ion-doped buried layer.

Claim 11 (original) The variable capacitor of claim 10, wherein the first type ion-doped buried layer is an N-type buried layer and the second type ion-doped region is a P-doped region.

Claim 12. (original) The variable capacitor of claim 10, wherein the structure further includes at least a second conductive layer connected with the second type ion-doped region.

Claim 13. (original) The variable capacitor of claim 10, wherein the structure further includes a metal silicide layer between the first type ion-doped buried layer and the first conductive layer.

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Claim 14. (new) The variable capacitor of claim 5, wherein the contact is isolated from the second type ion-doped region through an insulation layer.

Claim 15. (new) The variable capacitor of claim 14, wherein the first-type ion-doped buried layer has a second cavity and the conductive layer is over the second cavity of the first-type ion-doped buried layer.

Claim 16. (new) The variable capacitor of claim 15, wherein the structure further includes a second metal silicide layer on a surface of the second cavity of the first-type ion-doped buried layer and between the first type ion-doped buried layer and the conductive layer.

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**In The Drawings:**

Please substitute the attached replacement Fig. 6 for the pending Fig. 6. The only amendment made to Fig. 6 is the addition of the legend "Prior Art".

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**In The Title:**

Please amend the title of invention as follows:

**VARIABLE CAPACTOR STRUCTURE AND ~~METHOD OF MANUFACTURE~~**